**PRODUCT:** TFT TOUCH MODULE

**MODULE NO.: WKS43WV002-WCT** 

**SUPPLIER:** WKS Technology Co.,LTD

**DATE:** Mar 10, 2018

# **SPECIFICATION**

Revision: 0.0

WKS43WV002-WCT

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact WKS R&D department for updated specification and product status before design for this product or release of this order.

WRITTEN BY	CHECKED BY	APPROVED BY
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# **REVISION RECORD**

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2018-03-10	First release	Preliminary
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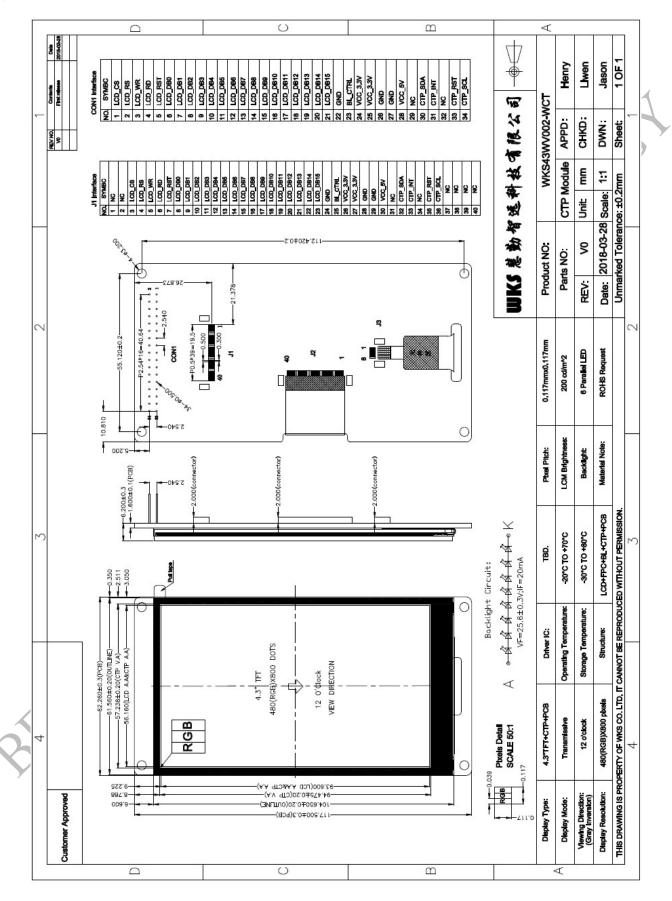




Item of general information		Unit		
LCD Display Size(Diagonal)		4.3		
Module Structure	LCD E	Display + CTP Touch + PCB	4	
LCD Display Type	Г	TFT/TRANSMISSIVE	30	
LCD Display Mode		Normally White	-	
Recommended Viewing Direction		6	o'clock	
Gray inversion Direction		12	o'clock	
Module size (W×H×T)		62.26×117.50×6.20	mm	
Active area (W×H)	,	56.16×93.60	mm	
Number of pixels(Resolution)		480RGB×800	pixel	
Pixel pitch (W×H)	$\Diamond$	0.117×0.117	mm	
Color Pixel Arrangement	) >	RGB Stripe	-	
LCD Driver IC		-	-	
Interface Type	LCD	16-bit 8080 interface	-	
interface Type	СТР	I2C interface		
Input voltage	5V&3.3V		V	
Power consumption	-		mW	
Color Numbers		-		
Backlight Type		White LED	-	



### 2, EXTERNAL DIMENSIONS



Version:0.0



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### 3, ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings means the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

### 4、ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC	Symbol	Min.	Тур.	Max.	Unit	
characteristics	,		0.2			
Module Operating voltage	VCC3.3V	-	3.3	-	V	
Module Operating voltage	VCC5V	-	5.0	-		
Input voltage 'H' level	VIH	0.7*VCC3.3	-	VCC3.3	V	
Input voltage 'L' level	VIL	VSS	-	0.3*VCC3.3	V	
Output voltage 'H' level	VOH	0.8* VCC3.3	-	VCC3.3	V	
Output voltage 'L' level	VOL	VSS	-	0.2*VCC3.3	V	

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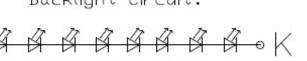
#### 5 BACKLIGHT CHARACTERISTICS

Item of backlight characteristics	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward Voltage	Vf	25.2	25.6	25.9	V	Notel
Forward Current	If	-	20	-	mA	
Number of LED	-	-	8	-	Piece	-
LED Connection mode	P/S	-	Serial	-	7	-
Lifetime of LED	-	-	10000		hour	Note2

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#### Note:

- Note1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and If=20mA.
- Note2: The LED lifetime define as the estimated time to 50% degradation of initial luminous. The LED lifetime could be decreased if operating If is lager than 20mA.
- > Backlight circuit:





Item of CTP	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	
Resolution	480 ×800	pixel	
Surface Hardness	6Н		-
Transparency	≥82%		-
Driver IC	-	<u></u>	-
Interface Type	I2C	-	-
Support Points	5	-	-
Sampling Rate	20~100	Hz	-
Supply voltage	3.3	V	-

BERRORE



### 7, ELECTRO-OPTICAL CHARACTERISTICS

Item (	of								
electro-op	otical	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
character	istics								
Response	time	Tr+Tf	$\theta=0$	-	20	-	ms	FIG 1.	4
Contrast F	Ratio	CR	$\emptyset=0$	-	350	-	-	FIG 2.	1
Luminance un	iformity	δWHITE	Ta=25°C	-	80	-	%	FIG 2.	3
Surface Lum	inance	Lv		-	200	-	cd/m2	FIG 2.	2
	White	White x		-	0.317	- /			
	WIIILE	White y		-	0.324	-	_	FIG 2.	5
	Red	Red x		-	0.633	<u> </u>			
CIE (x, y)	Keu	Red y	θ=0 Ø=0	-	0.341	<b>√</b> (			
chromaticity	Green	Green x	Ta=25°C	-	0.324	<u> </u>			3
	Green	Green y	10 25 0	- (	0.551	-			
	Blue	Blue x			0.153	-			
	Blue	Blue y		47.	0.143	-			
	Ø=90(1	2 o'clock)	^	11-	50	-	deg		
Viewing	Ø=270(	6 o'clock)	CD > 10	-	60	-	deg	FIG 3.	
angle range	Ø=0(3 d	o'clock)	CR ≥ 10	-	65	-	deg	FIG 3.	6
	Ø=180(	9 o'clock)	1	-	65	-	deg		
NTSC ratio		- (	-	-	50	-	%	-	-

**Note 1.** Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast \ Ratio(CR) = \frac{Average \ Surface \ Luminance \ with \ all \ white \ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average \ Surface \ Luminance \ with \ all \ black \ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$ 

**Note 2.** Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P 3,P4, P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance ( $\delta$ WHITE) is determined by measuring

luminance at each test position 1 through 9, and then dividing the maximum luminance of 9 points luminance by minimum luminance of 9 points luminance. For more information see FIG 2.

$$\delta \text{WHITE} = \frac{Minimum \, Surface \, Luminance \, with \, all \, white \, pixels \, (P1, P2, P3, P4, P5, P6, P7, P8, P9)}{Maximum \, Surface \, Luminance \, with \, all \, white \, pixels \, (P1, P2, P3, P4, P5, P6, P7, P8, P9)}$$

**Note 4.** Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1.

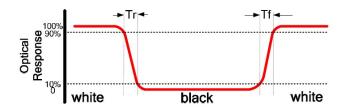
**Note 5.** CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

**Note 6.** Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

**Note 7.** For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

**Note 8.** For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time





### FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance

### uniformity, CIE (x, y) chromaticity

A: H/6; B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

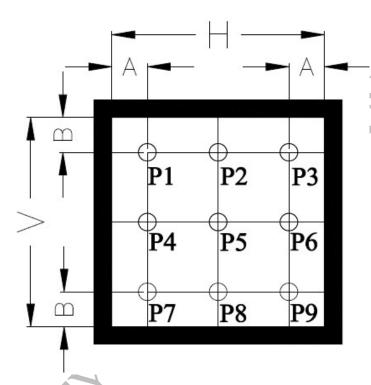
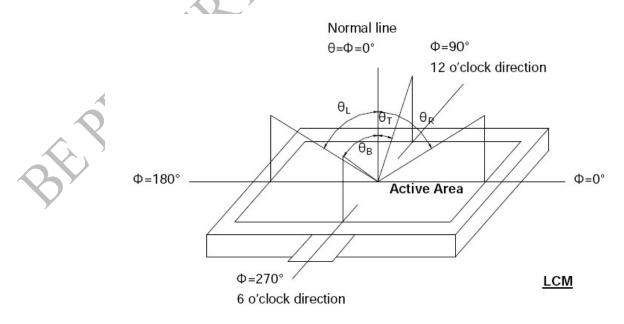


FIG.3. The definition of viewing angle



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### **8. INTERFACE DESCRIPTION**

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### A. Input Interface Description(CON1)

NO.	Symbol	I/O	DESCRIPTION		
1	CS	I	Chip select		
2	RS	I	Data/Command select		
3	WR	I	Write strobe signal		
4	RD	I	Read strobe signal		
5	RESET	I	LCD RESET signal, Low is active		
6~21	D0~D15	I/O	Data bus(D0:LSB; D15:MSB)		
22	GND	Power supply	Power ground		
23	BL_CTRL	I	Backlight control pin		
24~25	VCC_3.3V	Power supply	Module Power input (3.3V Typ.)		
26~27	GND	Power supply	Power ground		
28	VCC_5V		Module Power input (5.0V Typ.)		
29	NC	<u> </u>	No connection		
30	CTP_SDA	I	CTP I2C data input and output		
31	CTP_INT	О	CTP External interrupt to the host		
32	NC	-	No connection		
33	CTP_RST	I	CTP external reset signal, Low is active		
34	CTP_SCL	I	CTP I2C clock input		

### **B.** Input Interface Description(J1)

TOUCH MODULE

NO.	Symbol	I/O	DESCRIPTION		
1~2	NC	-	No connection		
3	CS	I	Chip select		
4	RS	I	Data/Command select		
5	WR	I	Write strobe signal		
6	RD	I	Read strobe signal		
7	RESET	I	LCD RESET signal, Low is active		
8~23	D0~D15	I/O	Data bus(D0:LSB; D15:MSB)		
24	GND	Power supply	Power ground		
25	BL_CTRL	I	Backlight control pin		
26~27	VCC_3.3V	Power supply	Module Power input (3.3V Typ.)		
28~29	GND	Power supply	Power ground		
30	VCC_5V		Module Power input (5.0V Typ.)		
31	NC	( <del>)</del>	No connection		
32	CTP_SDA	I	CTP I2C data input and output		
33	CTP_INT	О	CTP External interrupt to the host		
34	NC	-	No connection		
35	CTP_RST	I	CTP external reset signal, Low is active		
36	CTP_SCL	I	CTP I2C clock input		
37~40	NC	-	No connection		



### 9、INPUT TIMING

### **Parallel Interface Input Timing Table (80-Series MCU)**

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	t <sub>WC</sub>	Write cycle	33	-	ns	4
WR	t <sub>WRH</sub>	Control pulse "H" duration	15	-	ns	
	t <sub>WRL</sub>	Control pulse "L" duration	15	-	ns	
	t <sub>RC</sub>	Read cycle(ID)	160		ns	
RD(ID)	t <sub>RDH</sub>	Control pulse "H" duration(ID)	90		ns	When read ID data
	t <sub>RDL</sub>	Control pulse "L" duration(ID)	45	,	ns	
	t <sub>RCFM</sub>	Read cycle(FM)	400	1	ns	When read
RD(FM)	t <sub>RDHFM</sub>	Control pulse "H" duration(FM)	250	-	ns	from frame
	t <sub>RDLFM</sub>	Control pulse "L" duration(FM)	150	1	ns	memory
	t t	Address setup time(Write)	0	ı	ns	
RS	t <sub>AST</sub>	Address setup time(Read)	10	-	ns	
	t <sub>AHT</sub>	Address hold time	2	-	ns	
	t <sub>DST</sub>	Data setup time	15	-	ns	
	t <sub>DHT</sub>	Data hold time	10	-	ns	
D[15:0]	<b>t</b> <sub>RAT</sub>	Read access time(ID)	-	40	ns	
8	t <sub>RATFM</sub>	Read access time(FM)	-	150	ns	
,	t <sub>ODH</sub>	Output disable time	5	-	ns	



#### 10, RELIABILITY TEST CONDITIONS

**TOUCH MODULE** 

No.	Test Item	Test Condition
1	High Temperature Storage	80°C/120 hours
2	Low Temperature Storage	-30°C/120 hours
3	High Temperature Operating	70°C/120 hours
4	Low Temperature Operating	-20°C/120 hours
5	Temperature Cycle Storage	-20°C(30min.)~25(5min.)~70°C(30min.)×10cycles

### A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- Air bubble in the LCD;
- Sealleak;
- Non-display;
- Missing segments;
- Glass crack;
- Current is twice higher than initial value.

#### B, Remark:

- The test samples should be applied to only one test item.
- Sample size for each test item is 5~10pcs.
- Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

#### 11, INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 4.3 inch.

### 11.1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

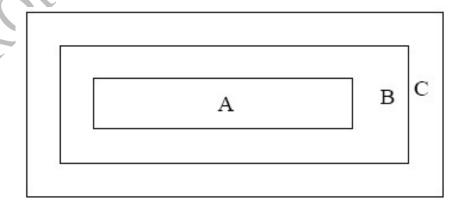
Minor defect: AQL 1.5

#### 11.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of  $20\sim40$ W light intensity, all directions for inspecting the sample should be within  $45^{\circ}$  against perpendicular line. (Normal temperature  $20\sim25^{\circ}$ C and normal humidity  $60\pm15\%$ RH)

## 11.3 Definition of Inspection Item.

A. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

#### Definition of some visual defect B.

		Because of losing all or part function, bad pixel dots appear bright and the
	Bright dot	size is more than 50% of one dot in which LCD panel is displaying under
		black pattern.
	Dark dot	Dots appear dark and unchanged in size in which LCD panel is displaying
		under pure red, green, blue picture, or pure whiter picture.

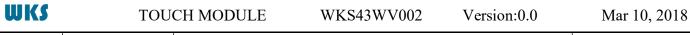
#### 11.4 **Major Defect**

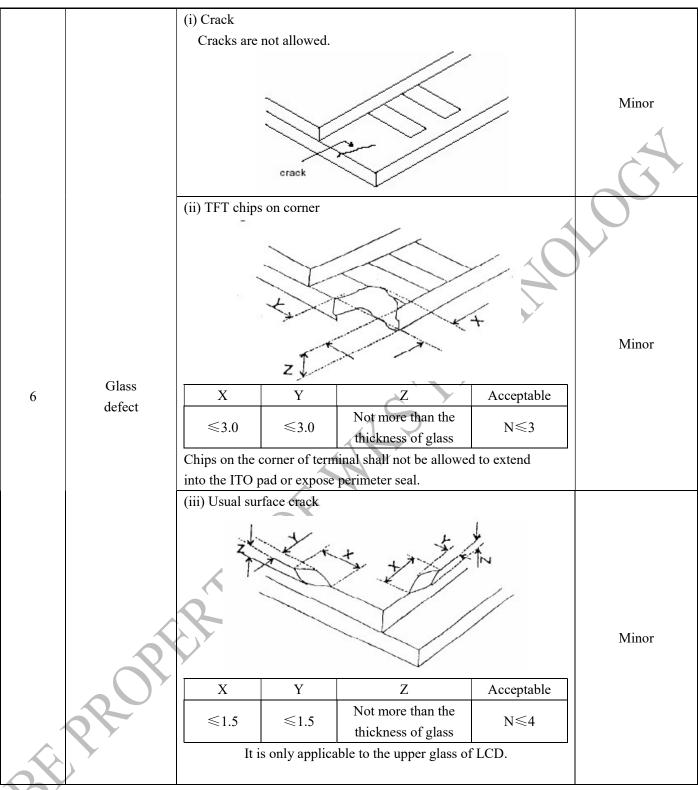
Item	Items to be	Inspection standard	Classification
No.	inspected	inspection standard	of defects
1	Functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Excess power consumption 6)Backlight no lighting, flickering and abnormal lighting	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

### 5. Minor Defect

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Item No.	Items to be inspected	Inspection standard				Classification of defects		
	Bright dot /dark dot defect		Zone Acceptable Qty					
				A+B				
				4.3"~7	" 7~10.1"	>10.1"	С	
		Bright pi	xel dot	1	2	3		
		Dark pix	Dark pixel dot 4		4	4		
1		2bright dots	s adjacent	0	0	0	Acceptable	Minor
1		2dark dots	adjacent	0	0	0	otab	Willion
		Total bright dot		5	6	7	e	
		Note: Minimun	n distance be	tween de	efective dots	is more than	5mm;	
			Pixel dots' function is normal, but bright dots caused by foreign material and other reasons are judged by the dot defect of 5.2.					
		Zon			Acceptable			
				A+B				ļ
		Size(mm)	4.3"	4.3"~7" 7~10.1" >10.1"			С	
	Dot defect	Ф ≤0.2	Accep	table /	Acceptable	Acceptable	Acc	
2		0.2< Ф ≤ 0	.5 4		5	6	Acceptable	Minor
2		Ф>0.5	0		0	0	able	Willion
		Note:						
	$\Phi = (x+y)/2$	1. Minimum dis	stance betwe	en defec	tive dots is 1	more than 5 m	m;	
		2. The quantity of defect is zero in operating condition.						
	R	Zon	e		Acceptable	Qty		
		Size (mm)		A+B				
3 ^	Linear	Length Wie	dth 4.3"	~7"	7∼10.1"	>10.1"	С	Minor
X	defect	Ignore W≤0		table   A	Acceptable	Acceptable	Ac	1,11101
D'		L≤5.0 0.05 W≤	Ι Δ		5	6	Acceptable	
		L>5.0 W>	0.1		0	0	e e	







### 11.6 Module Cosmetic Criteria

Item No.	Items to be inspected	Inspection Standard	Classification of defects			
1	Difference in Spec.	Not allowable	Major			
2	Pattern peeling	No substrate pattern peeling and floating	Major			
		No soldering missing	Major			
3	Soldering defects	No soldering bridge	Major			
		No cold soldering	Minor			
4	Resist flaw on PCB	V on PCB Visible copper foil (Φ0.5 mm or more) on substrate pattern is not allowed				
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major			
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor			
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor			
8	Accretion of metallic Foreign matter	Minor				
9	Stain	No stain to spoil cosmetic badly	Minor			
10	Plate discoloring	No plate fading, rusting and discoloring	Minor			
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor			
		b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor			
11	2. Flat packages	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.	Minor			
	3. Chips	(3/2) H ≥h ≥(1/2) H  \$\sqrt{\frac{1}{2}h} \sqrt{H}\$	Minor			
8)	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad h $\geq$ 0.13 mm. The diameter of solder ball d $\leq$ 0.15 mm.	Minor			
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor			
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major			